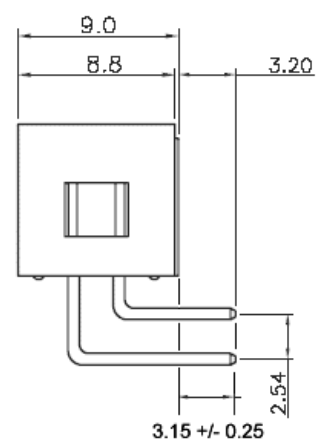


TOP VIEW
PCB LAYOUT RECOMMENDED



[2533] SERIES

Box Header, Type 1,
Pitch*Row 2.54mm*2.54mm,
Right Angle, Dip.

Physical:

Housing: PBT + 30% GF (UL94V-0)

Contact: Copper Alloy

Specifications:

Current Rating: 3A.

Insulation Resistance: 1000M ohm min

Contact Resistance: 30m ohm max

Dielectric Withstanding Voltage:

AC 500V For 1 Minute

Temperature Rating: -40°C To +105°C

Wave Soldering Temperature:

Lead Part: 245±5°C, 5Sec

RoHS Part: 260±5°C, 5Sec

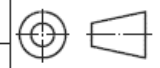
2533-14E-001 : 15u" All Poat

2533-14ET-001 : 15u" Gold Plating

5mm Mating Side Contact,

Tin Plating on PCB Side Contact

CUSTOMER COPY



UNIT:mm

SIZE: A4

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TITLE	Box Header R/A 14 Position 2x7
DWG NO.	2533-14E/ET-001
SCALE	1:1 SHEET 1 OF 1

REV.	DATE	APPD.	CHR.	DR.	TOLERANCE UNLESS OTHERWISE SPECIFIED
1.0	2006/10/13	DENNIS	DDP	FXF	LINEAR 0.0±0.38 0.00±0.25 ANGLES ±3